Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π–MOSV)

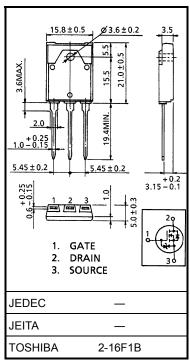
# 2SK2917

# Chopper Regulator, DC-DC Converter and Motor Drive Applications

 $\begin{array}{ll} \bullet & Low\ drain-source\ ON\ resistance & : R_{DS}\ (ON) = 0.21\ \Omega\ (typ.) \\ \bullet & High\ forward\ transfer\ admittance & : |Y_{fs}| = 17\ S\ (typ.) \\ \bullet & Low\ leakage\ current & : I_{DSS} = 100\ \mu A\ (max)\ (V_{DS} = 500\ V) \\ \bullet & Enhancement\ mode & : V_{th} = 2.0 {\sim} 4.0\ V\ (V_{DS} = 10\ V,\ I_D = 1\ mA) \\ \end{array}$ 

#### **Absolute Maximum Ratings (Ta = 25°C)**

Characteris	stics	Symbol	Rating	Unit	
Drain-source voltage		$V_{DSS}$	500	V	
Drain–gate voltage (R <sub>GS</sub> = 20 kΩ)		$V_{DGR}$	500	V	
Gate-source voltage		$V_{GSS}$	±30	V	
Drain current	DC (Note 1)	I <sub>D</sub>	18	А	
	Pulse (Note 1)	I <sub>DP</sub>	72		
Drain power dissipation	n (Ta = 25°C)	P <sub>D</sub>	90	W	
Single pulse avalanche	e energy (Note 2)	E <sub>AS</sub>	915	mJ	
Avalanche current		I <sub>AR</sub>	18	Α	
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	9	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	



Weight: 5.8 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	1.39	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	41.6	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD}$  = 90 V,  $T_{ch}$  = 25°C (initial), L = 4.8 mH,  $R_{G}$  = 25  $\Omega$ ,  $I_{AR}$  = 18 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device.

Please handle with caution.

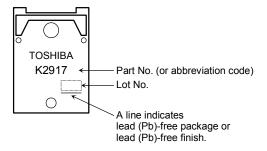
## **Electrical Characteristics (Ta = 25°C)**

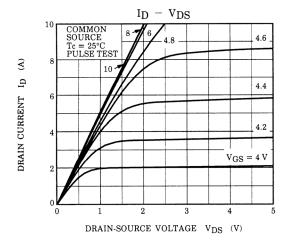
Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	irrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I <sub>G</sub> = ±10 μA, V <sub>DS</sub> = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V	_	_	100	μΑ
Drain-source br	eakdown voltage	V <sub>(BR) DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	500	_	_	V
Gate threshold v	oltage/	$V_{th}$	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	_	4.0	V
Drain-source Ol	N resistance	R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A	_	0.21	0.27	Ω
Forward transfer	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 10 A	10	17	_	S
Input capacitano	e	C <sub>iss</sub>			3720	_	
Reverse transfe	r capacitance	C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		340	_	pF
Output capacitance		C <sub>oss</sub>			1165		
Switching time	Rise time	t <sub>r</sub>	$V_{GS} = 10.0 \text{ A}$ $V_{GS} = 10.0 \text{ A}$ $V_{OUT} = 10.0 \text{ A}$ $V_{OUT} = 200 \text{ V}$ $V_{DD} = 200 \text{ V}$	_	30	_	
	Turn-on time	t <sub>on</sub>		_	70	_	nc
	Fall time	t <sub>f</sub>			50		ns
	Turn-off time	t <sub>off</sub>	Duty $\leq 1\%$ , $t_W = 10 \mu s$	I	290 —		
Total gate charge (gate-source plus gate-drain)		Qg			80		
Gate-source charge		$Q_{gs}$	V <sub>DD</sub> ≈ 400 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 18 A		48	_	nC
Gate-drain ("miller") Charge		$Q_{gd}$		_	32	_	

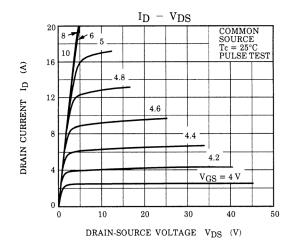
## Source-Drain Ratings and Characteristics (Ta = 25°C)

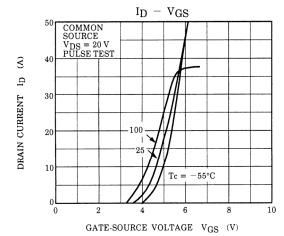
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_	_	18	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	_	72	Α
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 18 A, V <sub>GS</sub> = 0 V	_	_	-2.0	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 18 A, V <sub>GS</sub> = 0 V		540		ns
Reverse recovery charge	Q <sub>rr</sub>	dl <sub>DR</sub> / dt = 100 A / μs	_	5.4	_	μC

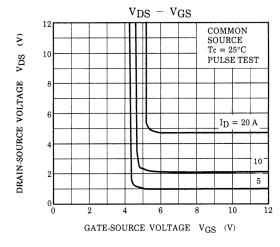
### Marking

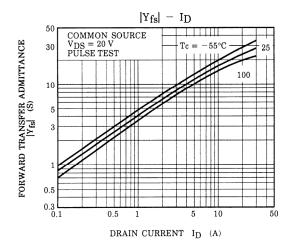


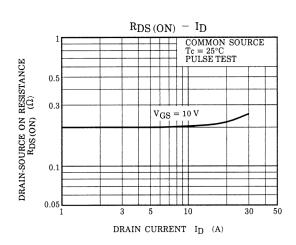


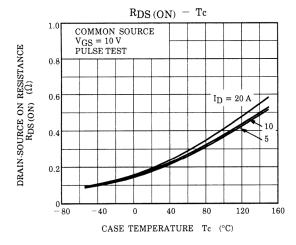


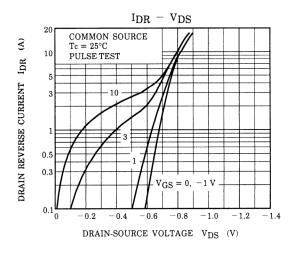


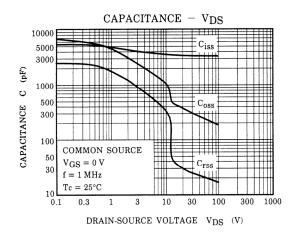


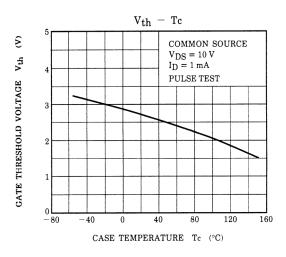


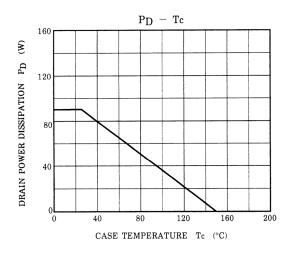


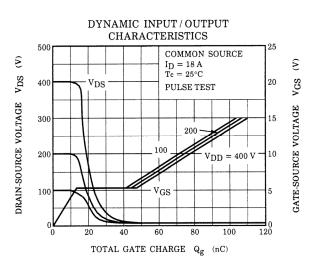


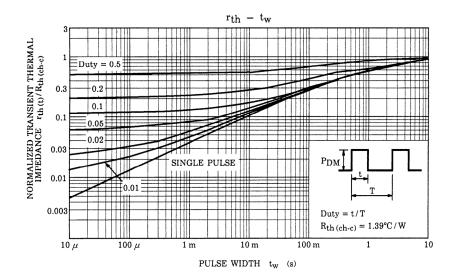


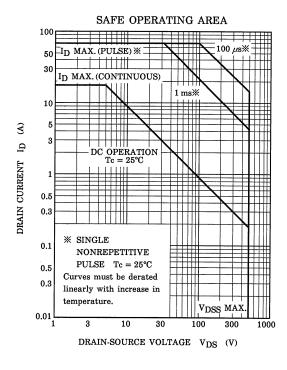


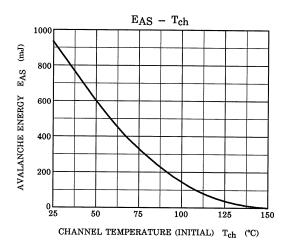


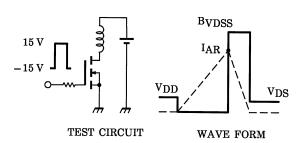












$$\begin{aligned} R_G &= 25~\Omega \\ V_{DD} &= 90~V,~L = 4.8~mH \end{aligned} \qquad E_{AS} = \frac{1}{2} \cdot L \cdot \end{aligned}$$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^{2} \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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